

# ZXMN10A08DN8

---

## 100V N-CANNEL ENHANCEMENT MODE MOSFET

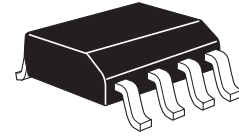
---

### SUMMARY

$V_{(BR)DSS} = 100V$ ;  $R_{DS(ON)} = 0.25\Omega$   $I_D = 2.1A$

### DESCRIPTION

This new generation of TRENCH MOSFETs from Zetex utilizes a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage, power management applications.



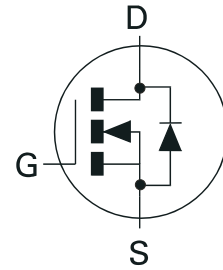
SO8

### FEATURES

- Low on-resistance
- Fast switching speed
- Low threshold
- Low gate drive
- Low profile SOIC package

### APPLICATIONS

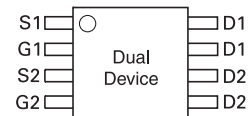
- DC - DC converters
- Power management functions
- Disconnect switches
- Motor control



### ORDERING INFORMATION

DEVICE	REEL SIZE	TAPE WIDTH	QUANTITY PER REEL
ZXMN10A08DN8TA	7"	12mm	500 units
ZXMN10A08DN8TC	13"	12mm	2,500 units

### PINOUT



Top View

### DEVICE MARKING

- ZXMN  
10A08D

# ZXMN10A08DN8

## ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-source voltage	$V_{DSS}$	100	V
Gate source voltage	$V_{GS}$	$\pm 20$	V
Continuous drain current $V_{GS}=10V; T_A=25^\circ C$ <sup>(b)</sup> $V_{GS}=10V; T_A=70^\circ C$ <sup>(b)</sup> $V_{GS}=10V; T_A=25^\circ C$ <sup>(a)</sup>	$I_D$	2.1 1.7 1.6	A
Pulsed drain current <sup>(c)</sup>	$I_{DM}$	9	A
Continuous source current (body diode) <sup>(b)</sup>	$I_S$	2.6	A
Pulsed source current (body diode) <sup>(c)</sup>	$I_{SM}$	9	A
Power dissipation at $T_A=25^\circ C$ <sup>(a)</sup>	$P_D$	1.25	W
Linear derating factor		10	mW/ $^\circ C$
Power dissipation at $T_A=25^\circ C$ <sup>(b)</sup>	$P_D$	1.8	W
Linear derating factor		14.5	mW/ $^\circ C$
Operating and storage temperature range	$T_j; T_{stg}$	-55 to +150	$^\circ C$

## THERMAL RESISTANCE

PARAMETER	SYMBOL	VALUE	UNIT
Junction to ambient (a)	$R_{\theta JA}$	100	$^\circ C/W$
Junction to ambient (b)	$R_{\theta JA}$	69	$^\circ C/W$

### NOTES

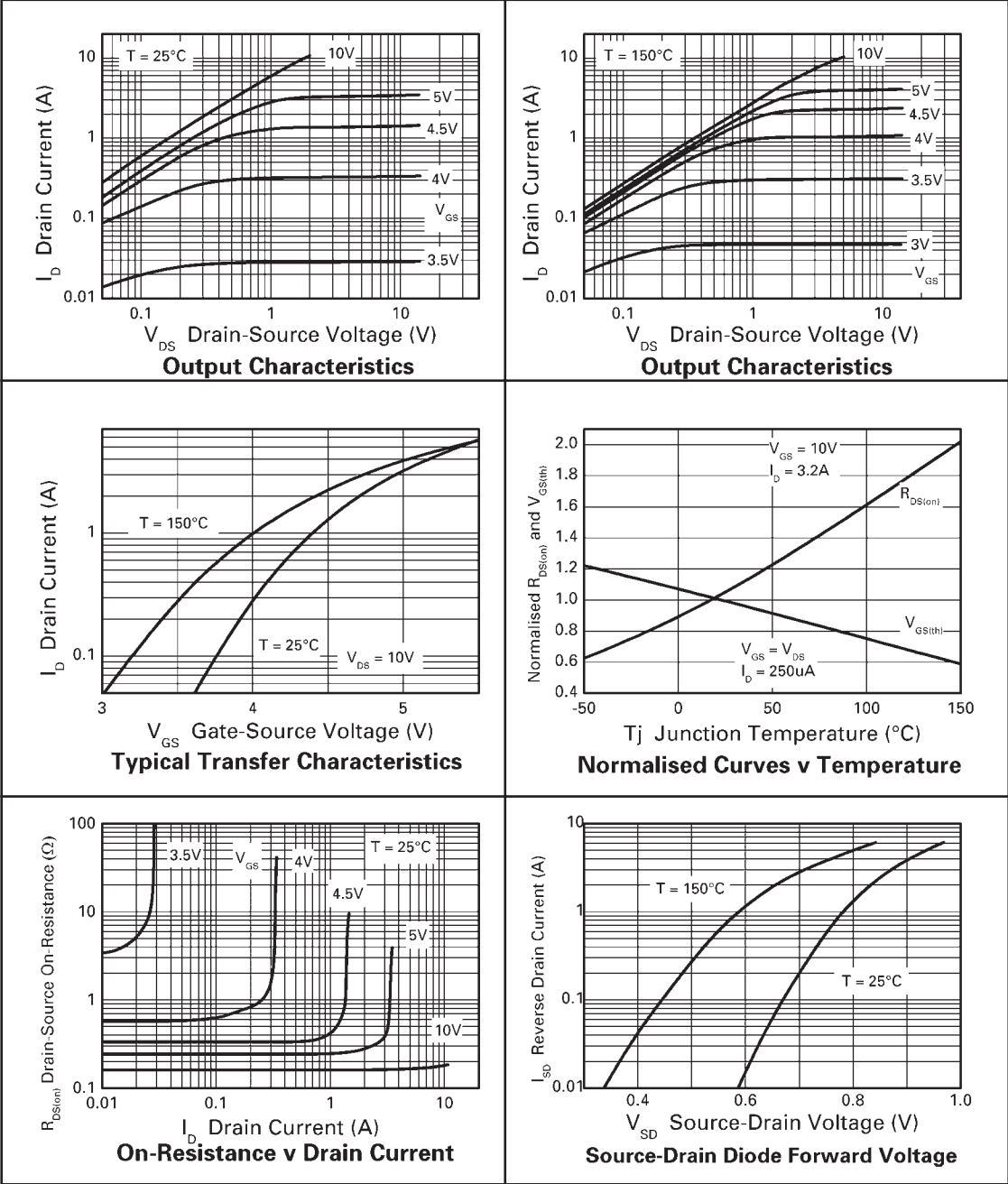
(a) For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions

(b) For a device surface mounted on FR4 PCB measured at  $t \leq 5$  secs.

(c) Repetitive rating 25mm x 25mm FR4 PCB,  $D = 0.02$ , pulse width 300 $\mu s$  - pulse width limited by maximum junction temperature. Refer to Transient Thermal Impedance graph

# ZXMN10A08DN8

## TYPICAL CHARACTERISTICS



# ZXMN10A08DN8

ELECTRICAL CHARACTERISTICS (at  $T_A = 25^\circ\text{C}$  unless otherwise stated).

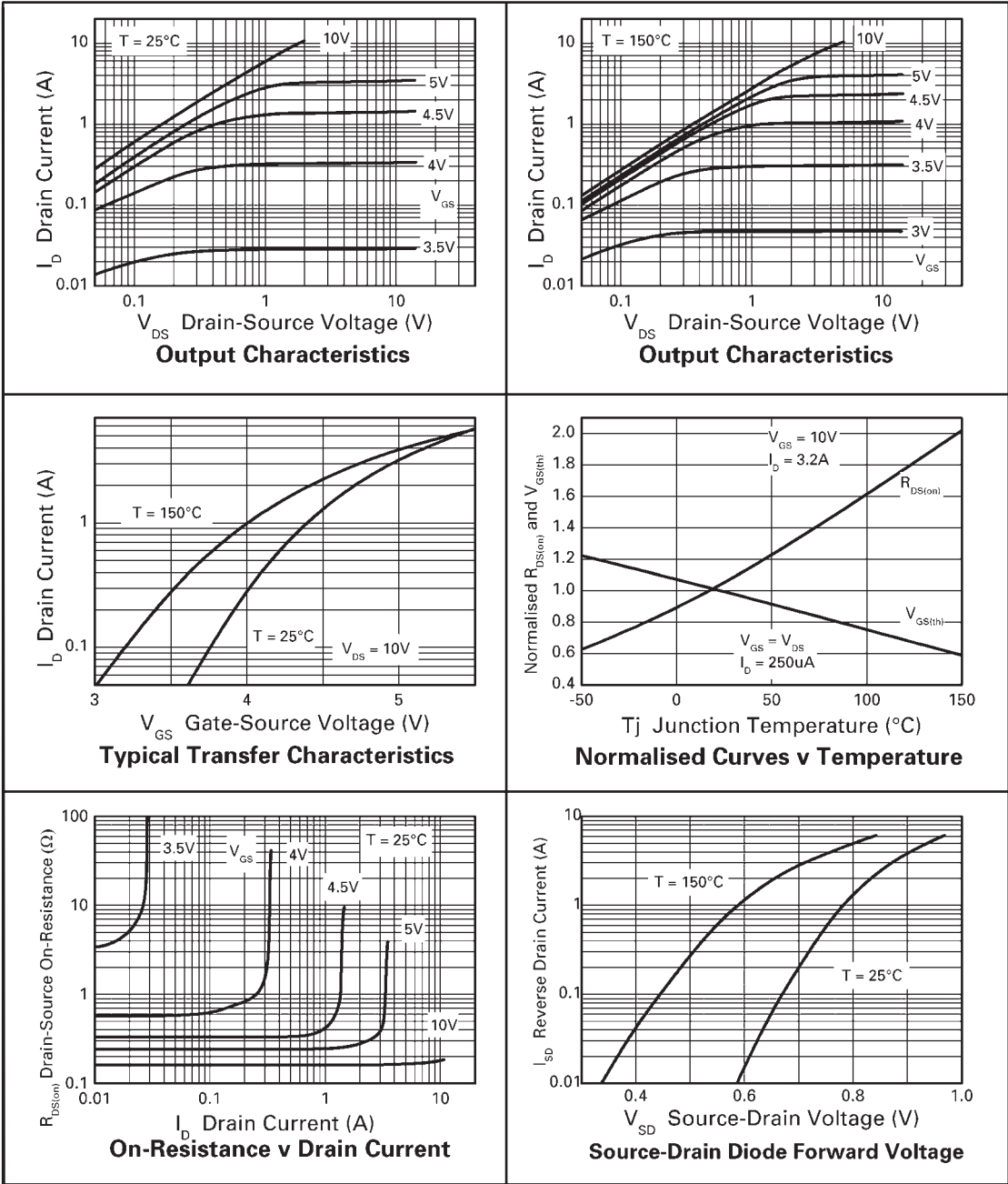
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
<b>STATIC</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	100			V	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$
Zero gate voltage drain current	$I_{DSS}$			0.5	$\mu\text{A}$	$V_{DS}=100\text{V}, V_{GS}=0\text{V}$
Gate-body leakage	$I_{GSS}$			100	nA	$V_{GS}=\pm 20\text{V}, V_{DS}=0\text{V}$
Gate-source threshold voltage	$V_{GS(th)}$	2.0			V	$I_D=250\mu\text{A}, V_{DS}=V_{GS}$
Static drain-source on-state resistance <sup>(1)</sup>	$R_{DS(on)}$			0.25 0.30	$\Omega$ $\Omega$	$V_{GS}=10\text{V}, I_D=3.2\text{A}$ $V_{GS}=6\text{V}, I_D=2.6\text{A}$
Forward transconductance <sup>(1)(3)</sup>	$g_{fs}$		5.0		S	$V_{DS}=15\text{V}, I_D=3.2\text{A}$
<b>DYNAMIC <sup>(3)</sup></b>						
Input capacitance	$C_{iss}$		405		pF	$V_{DS}=50\text{V}, V_{GS}=0\text{V},$ $f=1\text{MHz}$
Output capacitance	$C_{oss}$		28.2		pF	
Reverse transfer capacitance	$C_{rss}$		14.2		pF	
<b>SWITCHING <sup>(2)(3)</sup></b>						
Turn-on delay time	$t_{d(on)}$		3.4		ns	$V_{DD}=30\text{V}, I_D=1.2\text{A}$ $R_G=6.0\Omega, V_{GS}=10\text{V}$
Rise time	$t_r$		2.2		ns	
Turn-off delay time	$t_{d(off)}$		8		ns	
Fall time	$t_f$		3.2		ns	
Gate charge	$Q_g$		4.2		nC	$V_{DS}=50\text{V}, V_{GS}=5\text{V},$ $I_D=1.2\text{A}$
Total gate charge	$Q_g$		7.7		nC	$V_{DS}=50\text{V}, V_{GS}=10\text{V},$ $I_D=1.2\text{A}$
Gate-source charge	$Q_{gs}$		1.8		nC	
Gate-drain charge	$Q_{gd}$		2.1		nC	
<b>SOURCE-DRAIN DIODE</b>						
Diode forward voltage <sup>(1)</sup>	$V_{SD}$		0.87	0.95	V	$T_J=25^\circ\text{C}, I_S=3.2\text{A},$ $V_{GS}=0\text{V}$
Reverse recovery time <sup>(3)</sup>	$t_{rr}$		27		ns	$T_J=25^\circ\text{C}, I_F=1.2\text{A},$ $di/dt= 100\text{A}/\mu\text{s}$
Reverse recovery charge <sup>(3)</sup>	$Q_{rr}$		32		nC	

**NOTES:**

- (1) Measured under pulsed conditions. Width = 300 $\mu\text{s}$ . Duty cycle  $\leq 2\%$ .
- (2) Switching characteristics are independent of operating junction temperature.
- (3) For design aid only, not subject to production testing.

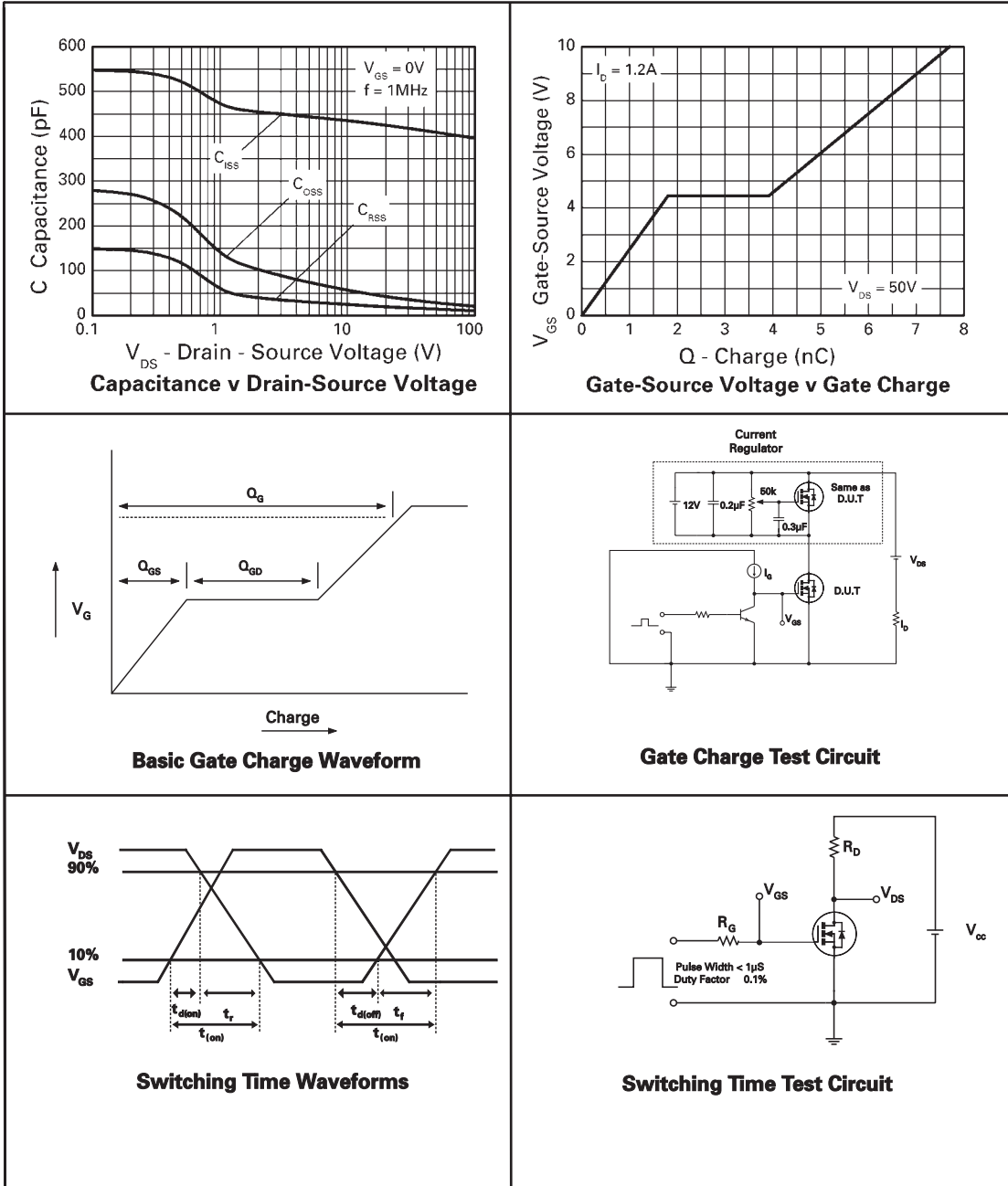
# ZXMN10A08DN8

## TYPICAL CHARACTERISTICS



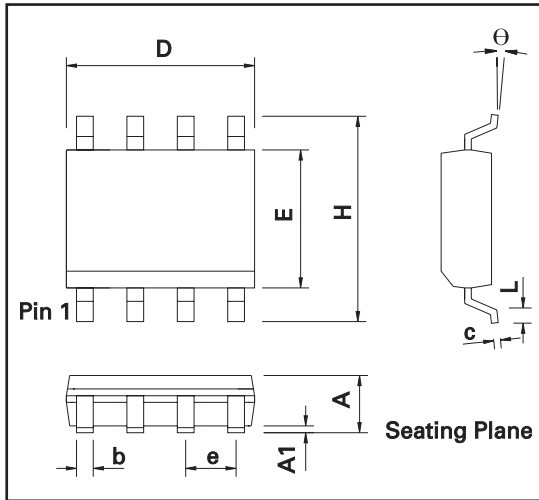
# ZXMN10A08DN8

## TYPICAL CHARACTERISTICS



# ZXMN10A08DN8

## PACKAGE OUTLINE



CONTROLLING DIMENSIONS IN MILLIMETERS APPROX CONVERSIONS INCHES

## PACKAGE DIMENSIONS

DIM	Millimeters		Inches		DIM	Millimeters		Inches	
	Min	Max	Min	Max		Min	Max	Min	Max
A	1.35	1.75	0.053	0.069	e	1.27 BSC		0.050 BSC	
A1	0.10	0.25	0.004	0.010	b	0.33	0.51	0.013	0.020
D	4.80	5.00	0.189	0.197	c	0.19	0.25	0.008	0.010
H	5.80	6.20	0.228	0.244	θ	0°	8°	0°	8°
E	3.80	4.00	0.150	0.157	h	0.25	0.50	0.010	0.020
L	0.40	1.27	0.016	0.050	-	-	-	-	-

© Zetex Semiconductors plc 2005

Europe	Americas	Asia Pacific	Corporate Headquarters
Zetex GmbH Streitfeldstraße 19 D-81673 München Germany	Zetex Inc 700 Veterans Memorial Hwy Hauppauge, NY 11788 USA	Zetex (Asia) Ltd 3701-04 Metroplaza Tower 1 Hing Fong Road, Kwai Fong Hong Kong	Zetex Semiconductors plc Zetex Technology Park Chadderton, Oldham, OL9 9LL United Kingdom
Telephone: (49) 89 45 49 49 0 Fax: (49) 89 45 49 49 49 <a href="mailto:europa.sales@zetex.com">europa.sales@zetex.com</a>	Telephone: (1) 631 360 2222 Fax: (1) 631 360 8222 <a href="mailto:usa.sales@zetex.com">usa.sales@zetex.com</a>	Telephone: (852) 26100 611 Fax: (852) 24250 494 <a href="mailto:asia.sales@zetex.com">asia.sales@zetex.com</a>	Telephone (44) 161 622 4444 Fax: (44) 161 622 4446 <a href="mailto:hq@zetex.com">hq@zetex.com</a>

These offices are supported by agents and distributors in major countries world-wide.

This publication is issued to provide outline information only which (unless agreed by the Company in writing) may not be used, applied or reproduced for any purpose or form part of any order or contract or be regarded as a representation relating to the products or services concerned. The Company reserves the right to alter without notice the specification, design, price or conditions of supply of any product or service.

For the latest product information, log on to [www.zetex.com](http://www.zetex.com)

ISSUE 4 - JANUARY 2005

# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Diodes Incorporated:](#)

[ZXMN10A08DN8TA](#)